

Electronic Acknowledgement Receipt

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Application Number:	10666671
International Application Number:	
Confirmation Number:	8251
Title of Invention:	Methods and apparatus of etch process control in fabrications of microstructures
First Named Inventor/Applicant Name:	Hongqin Shi
Customer Number:	23494
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Miscellaneous Incoming Letter	T62961_Small_Entity_Status.pdf	2478	no	1

Warnings:

Information:	
Total Files Size (in bytes):	2478
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